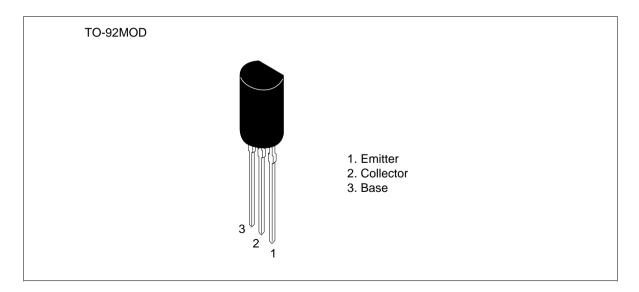
Silicon PNP Epitaxial

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Application

- Low frequency high voltage amplifier
- Complementary pair with 2SD755, 2SD756 and 2SD756A

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

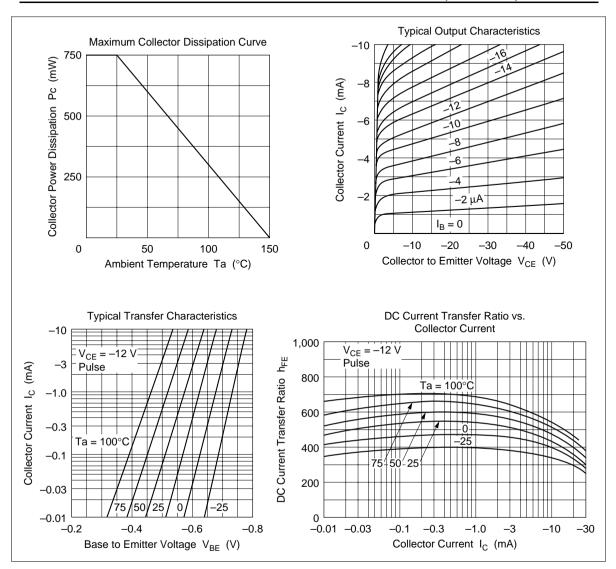
Item	Symbol	2SB715	2SB716	2SB716A	Unit
Collector to base voltage	V_{CBO}	-100	-120	-140	V
Collector to emitter voltage	V _{CEO}	-100	-120	-140	V
Emitter to base voltage	V _{EBO}	- 5	- 5	- 5	V
Collector current	I _c	- 50	-50	-50	mA
Collector power dissipation	P _c	750	750	750	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

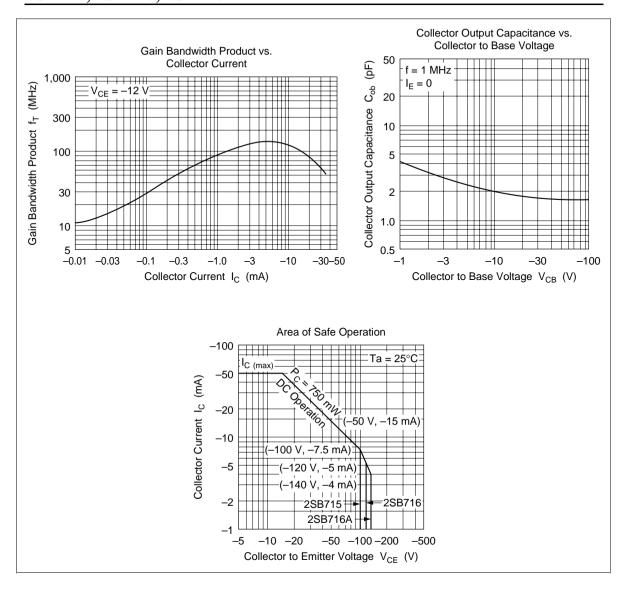
Electrical Characteristics (Ta = 25°C)

		2SB715 2SB716		2SB716A								
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-100	_	_	-120	_	_	-140	_	_	V	$I_{C} = -10 \mu\text{A}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-100	_	-	-120	_	_	-140	_	_	٧	$I_{C} = -1 \text{ mA},$ $R_{BE} = \infty$
Collector cutoff current	I _{CBO}	_	_	-0.5	_	_	_	_	_	_	μΑ	$V_{CB} = -80 \text{ V}, I_{E} = 0$
		_	_	_	_	_	-0.5	_	_	-0.5	μΑ	$V_{CB} = -100 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1} *1	250	_	800	250	_	800	250	_	500		$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
	h _{FE2}	125	_	_	125	_	_	125	_	_		$V_{CE} = -12 \text{ V},$ $I_{C} = -10 \text{ mA}$
Base to emitter voltage	V_{BE}	_	_	-0.75	_	_	-0.75	_	_	-0.75	٧	$V_{CE} = -12 \text{ V},$ $I_{C} = -2 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-0.2	_	_	-0.2	-	_	-0.2	٧	$I_C = -10 \text{ mA},$ $I_B = -1 \text{ mA}$
Gain bandwidth product	f _T	_	150	_	_	150	_	_	150	_	MHz	$V_{CE} = -12 \text{ V},$ $I_{C} = -5 \text{ mA}$
Collector output capacitance	Cob	_	1.8	_	_	1.8	_	_	1.8	_	pF	$V_{CB} = -25 \text{ V}, I_{E} = 0,$ f = 1 MHz

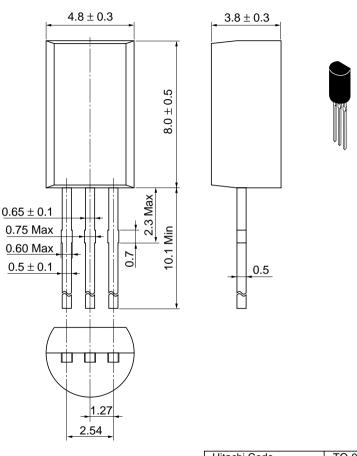
Note: 1. The 2SB715, 2SB716 and 2SB716A are grouped by $h_{\mbox{\tiny FE1}}$ as follows.

	ט	E
2SB715, 2SB716	250 to 500	400 to 800
2SB716A	250 to 500	_





Unit: mm



Hitachi Code TO-92 Mod

JEDEC —

EIAJ Conforms

Weight (reference value) 0.35 g

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